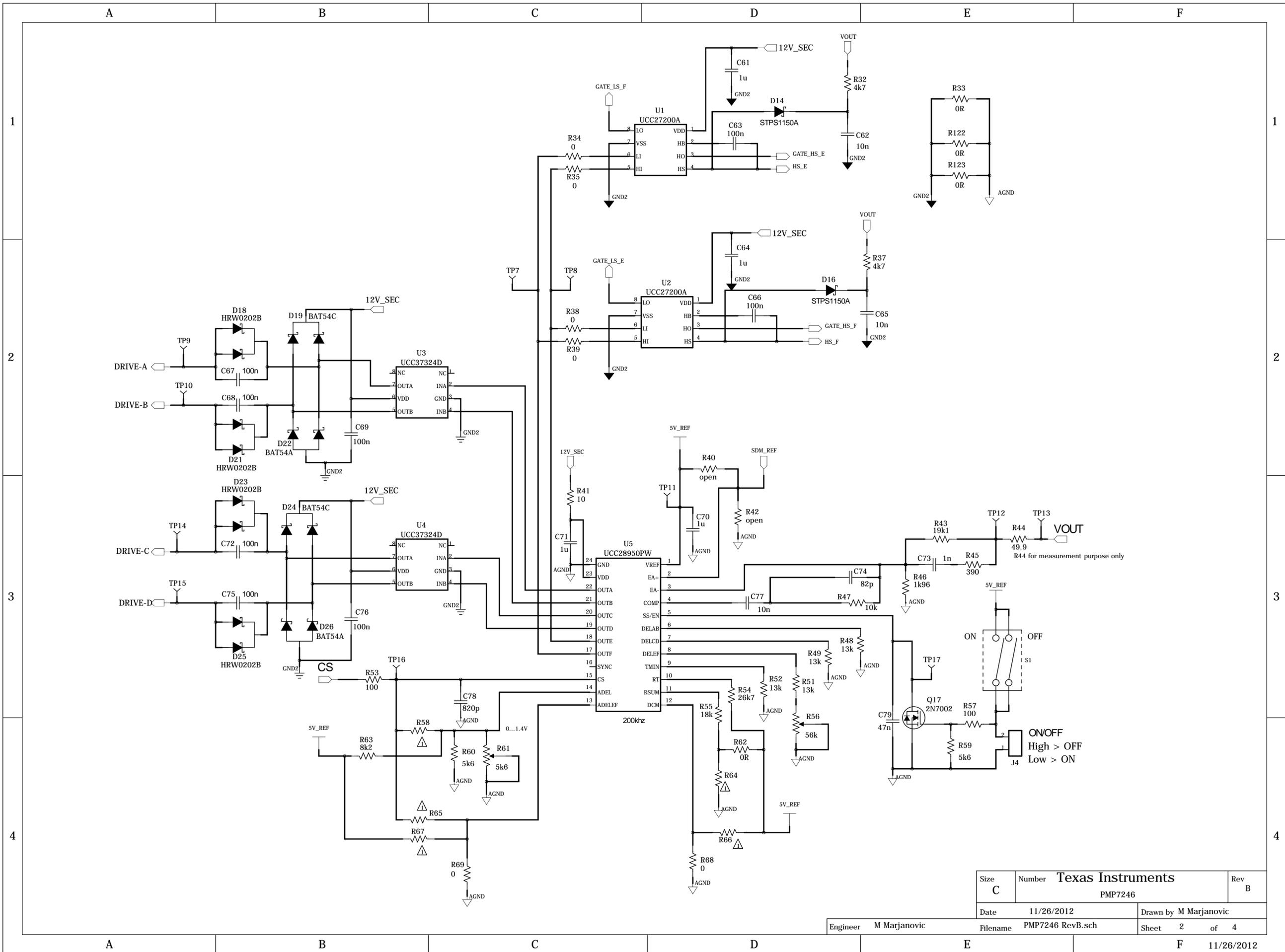


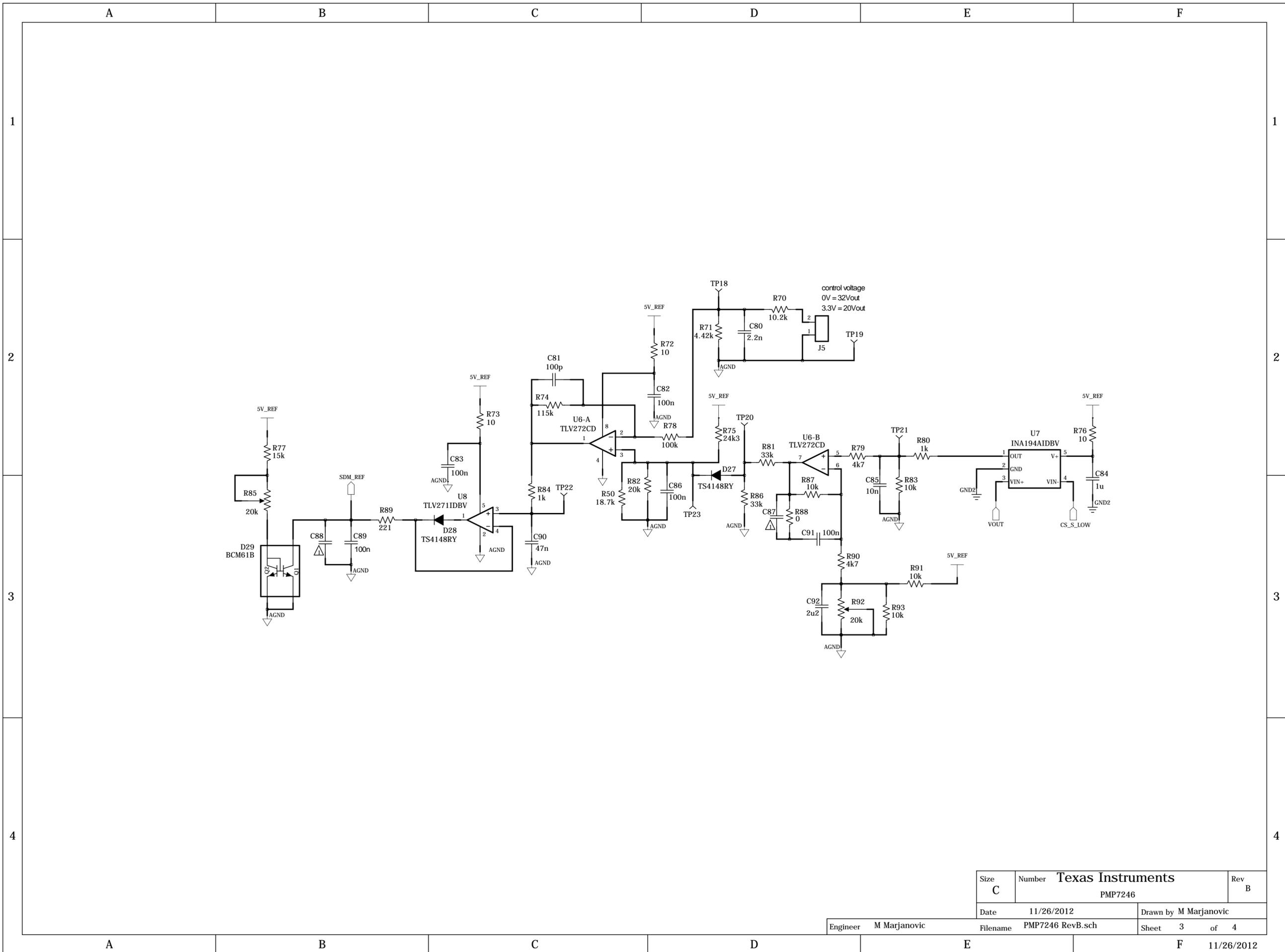
△ DO NOT POPULATE

Texas Instruments

|          |              |                       |                         |       |        |
|----------|--------------|-----------------------|-------------------------|-------|--------|
| Title    |              |                       | 350W SDM SMPS + 60W AUX |       |        |
| Size     | Number       |                       |                         | Rev   |        |
| C        | PMP7246      |                       |                         | B     |        |
| Date     | 11/26/2012   | Drawn by M Marjanovic |                         |       |        |
| Engineer | M Marjanovic | Filename              | PMP7246 RevB.sch        | Sheet | 1 of 4 |

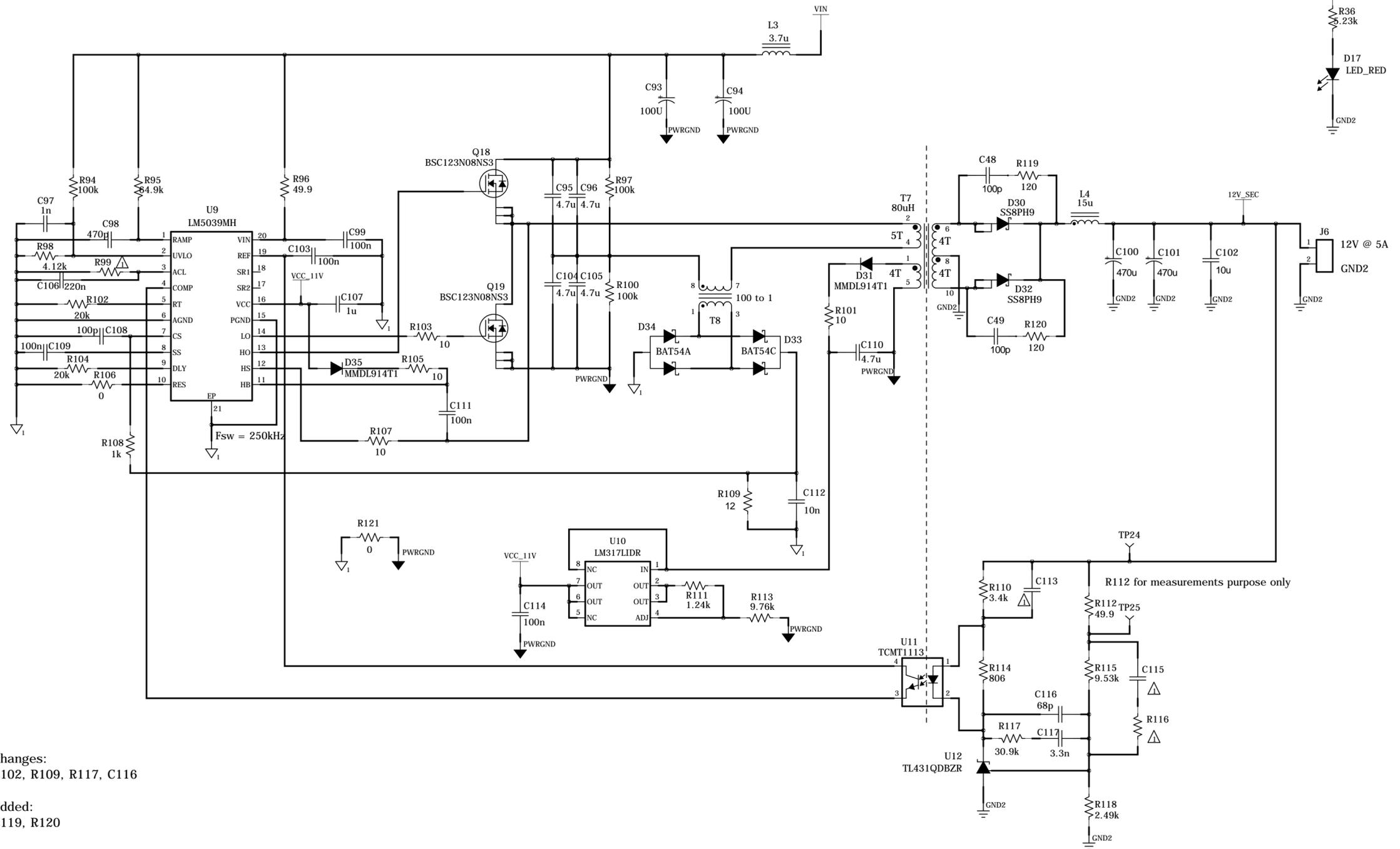


|                  |                             |                          |                  |
|------------------|-----------------------------|--------------------------|------------------|
| Size<br><b>C</b> | Number<br><b>11/26/2012</b> | <b>Texas Instruments</b> | Rev<br><b>B</b>  |
|                  |                             | <b>PMP7246</b>           |                  |
| Date             | 11/26/2012                  | Drawn by M Marjanovic    |                  |
| Engineer         | M Marjanovic                | Filename                 | PMP7246 RevB.sch |
|                  |                             | Sheet                    | 2 of 4           |



|                          |                              |                          |                 |
|--------------------------|------------------------------|--------------------------|-----------------|
| Size<br><b>C</b>         | Number<br><b>3</b>           | <b>Texas Instruments</b> | Rev<br><b>B</b> |
|                          |                              | <b>PMP7246</b>           |                 |
| Date<br>11/26/2012       | Drawn by M Marjanovic        |                          |                 |
| Engineer<br>M Marjanovic | Filename<br>PMP7246 RevB.sch | Sheet<br>3               | of 4            |

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Changes:  
R102, R109, R117, C116

Added:  
R119, R120

|                          |  |                 |
|--------------------------|--|-----------------|
| Size<br>C                | Number<br>Texas Instruments<br>PMP7246 | Rev<br>B        |
| Date<br>11/26/2012       | Drawn by M Marjanovic                  |                 |
| Engineer<br>M Marjanovic | Filename<br>PMP7246 RevB.sch           | Sheet<br>4 of 4 |

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